

Surface Mount Fast Recovery Rectifiers

FEATURES

- Glass passivated junction chip
- Ideal for automated placement
- Fast switching for high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

MECHANICAL DATA

Case: Sub SMA

Molding compound, UL flammability classification rating 94V-0 Base P/N with suffix "G" on packing code - green compound (halogen-free) Base P/N with prefix "H" on packing code - AEC-Q101 qualified **Terminal:** Matte tin plated leads, solderable per JESD22-B102 Meet JESD 201 class 1A whisker test with prefix "H" on packing code meet JESD 201 class 2 whisker test **Polarity:** Indicated by cathode band **Weight:** 0.019 g (approximately)



Sub SMA





	SYMBOL	RS1	RS1	RS1	RS1	RS1	RS1	RS1	S1	
PARAMETER		AL	BL	DL	GL	JL	KL	ML	UNIT	
Marking code		RAL	RBL	RDL	RGL	RJL	RKL	RML		
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V	
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V	
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	V	
Maximum average forward rectified current	I _{F(AV)}	0.8			А					
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	30			A					
Maximum instantaneous forward voltage (Note 1) @ 0.8 A	V _F	1.3				V				
Maximum reverse current @ rated VR T _J =25 $^{\circ}$ C T _J =125 $^{\circ}$ C	I _R	5 50			μA					
Typical junction capacitance (Note 2)	Cj	10		pF						
Maximum reverse recovery time (Note 3)	Trr	150 250 500		00	ns					
Typical thermal resistance	R _{θjL} R _{θjA}	32 105			^o C/W					
Operating junction temperature range	TJ	- 55 to +150			°C					
Storage temperature range	T _{STG}	- 55 to +150			°C					

Note 1: Pulse test with PW=300µs, 1% duty cycle

Note 2: Measured at 1 MHz and Applied VR=4.0 Volts.

Note 3: Reverse Recovery Test Conditions: I_F =0.5A, I_R =1.0A, I_{RR} =0.25A



RS1AL thru RS1ML

Taiwan Semiconductor

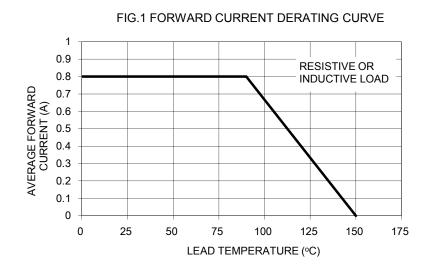
ORDERING INFORMATION					
PART NO.	AEC-Q101	PACKING CODE	GREEN COMPOUND	PACKAGE	PACKING
	QUALIFIED		CODE		
		RU	Suffix "G"	Sub SMA	1,800 / 7" Plastic reel (8mm tape)
		RV		Sub SMA	3,000 / 7" Plastic reel (8mm tape)
		RT		Sub SMA	7,500 / 13" Paper reel (8mm tape)
		MT		Sub SMA	7,500 / 13" Plastic reel (8mm tape)
		RQ		Sub SMA	10,000 / 13" Paper reel (8mm tape)
RS1xL	Prefix "H"	MQ		Sub SMA	10,000 / 13" Plastic reel (8mm tape)
(Note 1)		R3		Sub SMA	1,800 / 7" Plastic reel (12mm tape)
		RF		Sub SMA	3,000 / 7" Plastic reel (12mm tape)
		R2		Sub SMA	7,500 / 13" Paper reel (12mm tape)
		M2		Sub SMA	7,500 / 13" Plastic reel (12mm tape)
		RH		Sub SMA	10,000 / 13" Paper reel (12mm tape)
		MH		Sub SMA	10,000 / 13" Plastic reel (12mm tape)

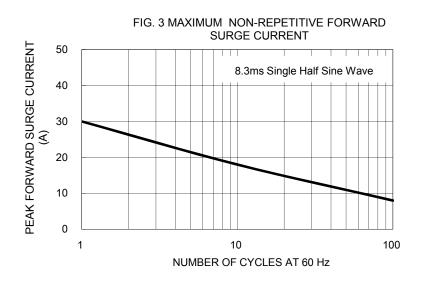
Note 1: "x" defines voltage from 50V (RS1AL) to 1000V (RS1ML)

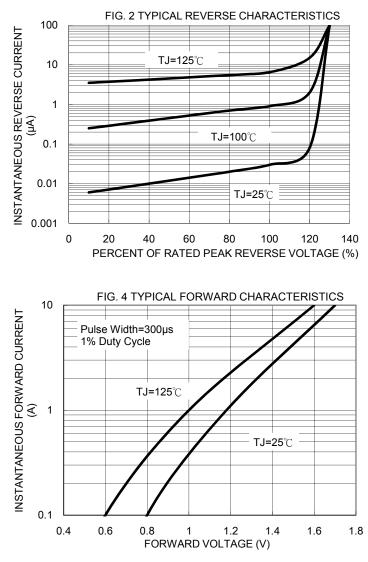
EXAMPLE					
PREFERRED P/N	PART NO.	AEC-Q101 QUALIFIED	PACKING CODE	GREEN COMPOUND CODE	DESCRIPTION
RS1ML RU	RS1ML		RU		
RS1ML RUG	RS1ML		RU	G	Green compound
RS1MLHRU	RS1ML	Н	RU		AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES

(TA=25 $^{\circ}$ C unless otherwise noted)





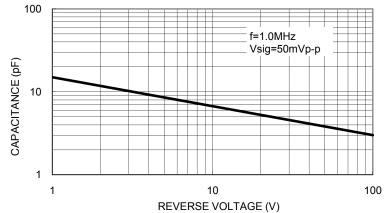


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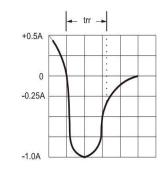


FIG. 5 TYPICAL JUNCTION CAPACITANCE

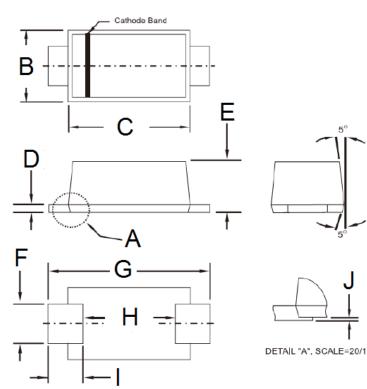
FIG.6- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM



50Ω NONINDUCTIVE 10Ω NONINDUCTIVE w (-) DUT PULSE GENERATOR (NOTE 2) (+) 50Vdc (approx) (-) (+) NOTES: 1. Rise Time=7ns max. Input Impedance= 1 megohm 22pf 2. Rise Time=10ns max. Sourse Impedance= 50 ohms



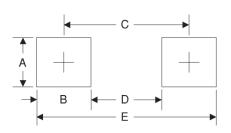
PACKAGE OUTLINE DIMENSIONS





DIM.	Unit	(mm)	Unit (inch)		
DIN.	Min	Мах	Min	Max	
В	1.70	1.90	0.067	0.075	
С	2.70	2.90	0.106	0.114	
D	0.16	0.30	0.006	0.012	
Е	1.23	1.43	0.048	0.056	
F	0.80	1.20	0.031	0.047	
G	3.40	3.80	0.134	0.150	
Н	2.45	2.60	0.096	0.102	
I	0.35	0.85	0.014	0.033	
J	0.00	0.10	0.000	0.004	

SUGGESTED PAD LAYOUT



P/N

G

F

YW

Symbol	Unit (mm)	Unit (inch)
A	1.4	0.055
В	1.2	0.047
С	3.1	0.122
D	1.9	0.075
E	4.3	0.169

MARKING DIAGRAM



- = Marking Code
- = Green Compound

= Date Code

= Factory Code

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